



## Features

|                  |  |
|------------------|--|
| Package          | 3in1 Side Viewing (Right Angle) type<br>Out dimension 4.5 × 1.15 × 1.35mm ( L x W x H )  |
| Product features | <ul style="list-style-type: none"> <li>• RGB tri-color emitting LED</li> <li>• Lead-free soldering compatible</li> <li>• RoHS compliant</li> </ul> |

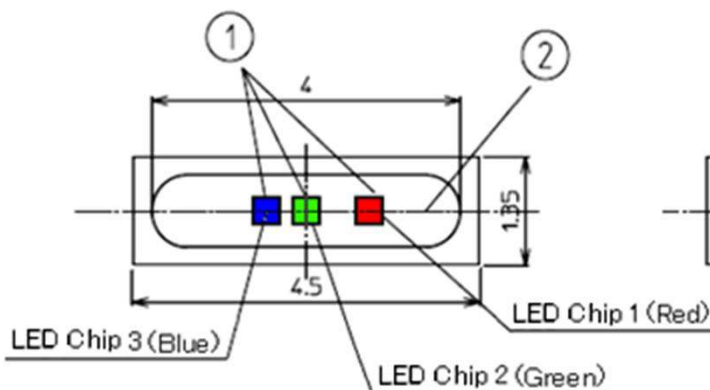
## Recommended Applications

Cellular Phone, Home Appliances, Amusement Equipment, Other General Applications

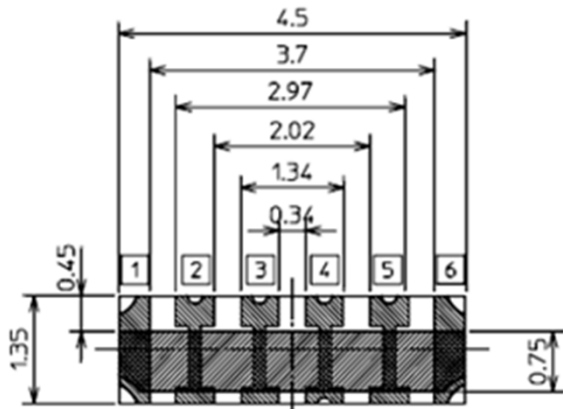
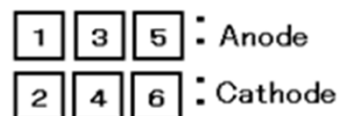
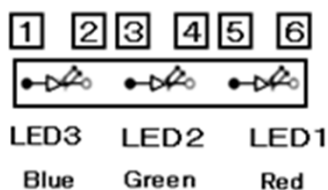
# Outline Dimensions

# ARGB1318FS-TM

Unit : mm  
Weight : 11.5mg  
Tolerance : ± 0.2



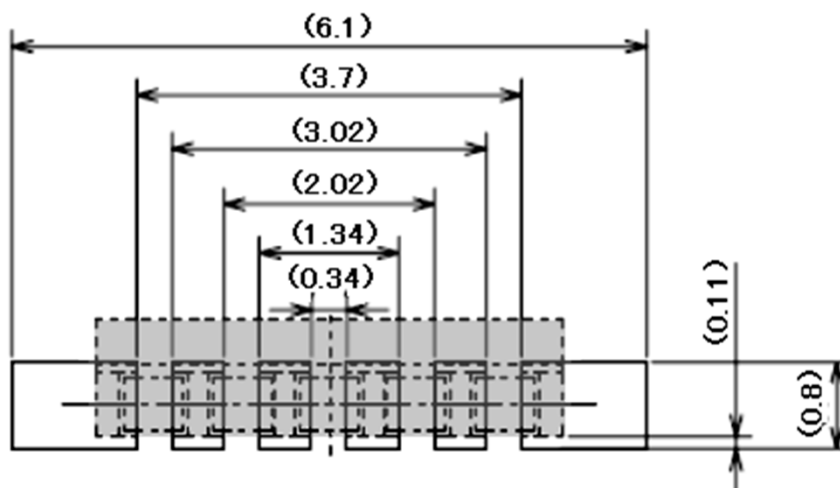
### INSIDE CIRCUIT



| SYMBOL | PART NAME   | MATERIALS      | QTY. |
|--------|-------------|----------------|------|
| ①      | LED Die     | AlGaInP, InGaN | 3    |
| ②      | Substrate   | Glass Fabrics  | 1    |
| ③      | Encapsulant | Silicone Resin | 1    |

## Recommended Pad

Unit : mm



## 【 Product Overview 】

|                |             |             |             |
|----------------|-------------|-------------|-------------|
|                | LED Die (1) | LED Die (2) | LED Die (3) |
| Material       | AlGaInP     | InGaN       | InGaN       |
| Emitting Color | RED         | GREEN       | BLUE        |
| Lens Color     | MILKY WHITE |             |             |

## 【 Absolute Maximum Ratings 】

(Ta=25°C)

| ITEM   | SYMBOL                     | LED Die (1)      | LED Die (2) | LED Die (3) | UNITS |       |
|--|----------------------------|------------------|-------------|-------------|-------|-------|
| Power Dissipation                                      | $P_d$                      | 90               | 100         | 53          | mW    |       |
| Total Value of Power Dissipation                       | $P_d$                      | <b>243 ※1</b>    |             |             | mW    |       |
| Forward Current (1 chip emitting)                      | $I_F$                      | 30               | 30          | 30          | mA    |       |
| Forward Current (3 chips emitting)                     | $I_F$                      | 30               | 25          | 15          | mA    |       |
| Repetitive Peak Forward Current                        | $I_{FRM}$                  | 100              | 100         | 100         | mA    |       |
| Current Derate Linearly<br>(Derate Linearly From 60°C) | DC (1 chip emitting)       | $\Delta I_F$     | 0.750       | 0.750       | 0.750 | mA/°C |
|  | DC (2 or 3 chips emitting) |                  | 0.75        | 0.625       | 0.375 | mA/°C |
|  | Pulse (1 chip emitting)    | $\Delta I_{FRM}$ | 2.50        | 2.50        | 2.50  | mA/°C |
| Reverse Voltage  | $V_R$                      | 5                | 5           | 5           | V     |       |
| Operating Temperature                                  | $T_{opr}$                  | -40 ~ +85        |             |             | °C    |       |
| Storage Temperature                                    | $T_{stg}$                  | -40 ~ +100       |             |             | °C    |       |

Notes ※ 1. Forward Current should not exceed Max. Total Value of Power Dissipation (3 chips emitting).

See technical data for Total Value of Power Dissipation at 60 °C or more.

※ 2.  $I_{FRM}$  Conditions : Pulse width  $\leq$  1ms, Duty  $\leq$  1/20

## 【 Electro-Optical Characteristics 】

### LED Die (1) **RED**

(Ta=25°C)

| ITEM                | SYMBOL      | CONDITIONS          | MIN. | TYP. | MAX. | UNITS         |
|---------------------|-------------|---------------------|------|------|------|---------------|
| Forward Voltage     | $V_F$       | $I_F = 23\text{mA}$ | 1.7  | 2.1  | 2.8  | V             |
| Reverse Current     | $I_R$       | $V_R = 5\text{V}$   | —    | —    | 50   | $\mu\text{A}$ |
| Luminous Intensity  | $I_V$       | $I_F = 23\text{mA}$ | —    | 500  | —    | mcd           |
| Dominant Wavelength | $\lambda_d$ | $I_F = 23\text{mA}$ | —    | 622  | —    | nm            |

### LED Die (2) **GREEN**

(Ta=25°C)

| ITEM                | SYMBOL      | CONDITIONS          | MIN. | TYP.  | MAX. | UNITS         |
|---------------------|-------------|---------------------|------|-------|------|---------------|
| Forward Voltage     | $V_F$       | $I_F = 23\text{mA}$ | 2.6  | 3.0   | 3.7  | V             |
| Reverse Current     | $I_R$       | $V_R = 5\text{V}$   | —    | —     | 50   | $\mu\text{A}$ |
| Luminous Intensity  | $I_V$       | $I_F = 23\text{mA}$ | —    | 1,100 | —    | mcd           |
| Dominant Wavelength | $\lambda_d$ | $I_F = 23\text{mA}$ | —    | 525   | —    | nm            |

### LED Die (3) **BLUE**

(Ta=25°C)

| ITEM                | SYMBOL      | CONDITIONS          | MIN. | TYP. | MAX. | UNITS         |
|---------------------|-------------|---------------------|------|------|------|---------------|
| Forward Voltage     | $V_F$       | $I_F = 14\text{mA}$ | 2.4  | 2.9  | 3.5  | V             |
| Reverse Current     | $I_R$       | $V_R = 5\text{V}$   | —    | —    | 50   | $\mu\text{A}$ |
| Luminous Intensity  | $I_V$       | $I_F = 14\text{mA}$ | —    | 200  | —    | mcd           |
| Dominant Wavelength | $\lambda_d$ | $I_F = 14\text{mA}$ | —    | 472  | —    | nm            |

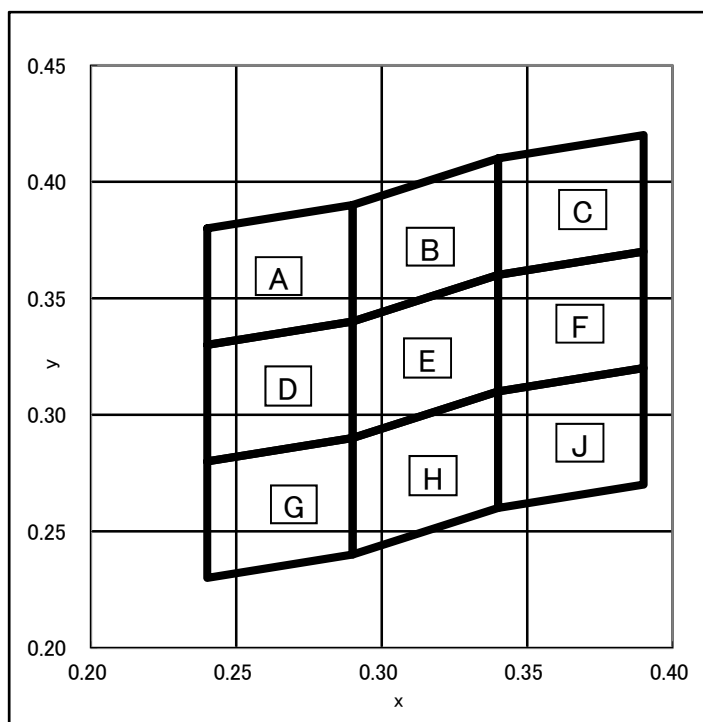
### All LED Emitting

(Ta=25°C)

| ITEM                     | SYMBOL | CONDITIONS   | MIN. | TYP.  | MAX. | UNITS |
|--------------------------|--------|--|------|-------|------|-------|
| Luminous Intensity       | $I_V$  | RED : $I_F=23\text{mA}$<br>GREEN : $I_F=23\text{mA}$<br>BLUE : $I_F=14\text{mA}$ | -    | 1,800 | -    | mcd   |
| Chromaticity Coordinates | x      |  | -    | 0.315 | -    | -     |
|                          | y      |  | -    | 0.310 | -    | -     |

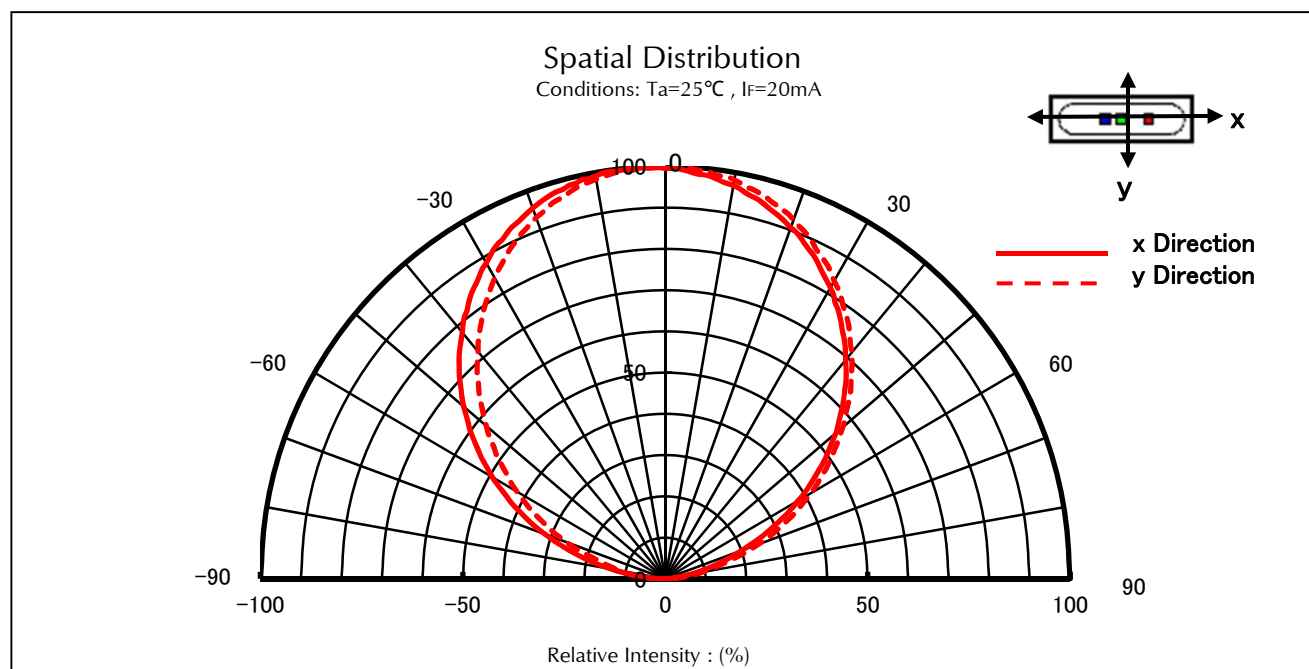
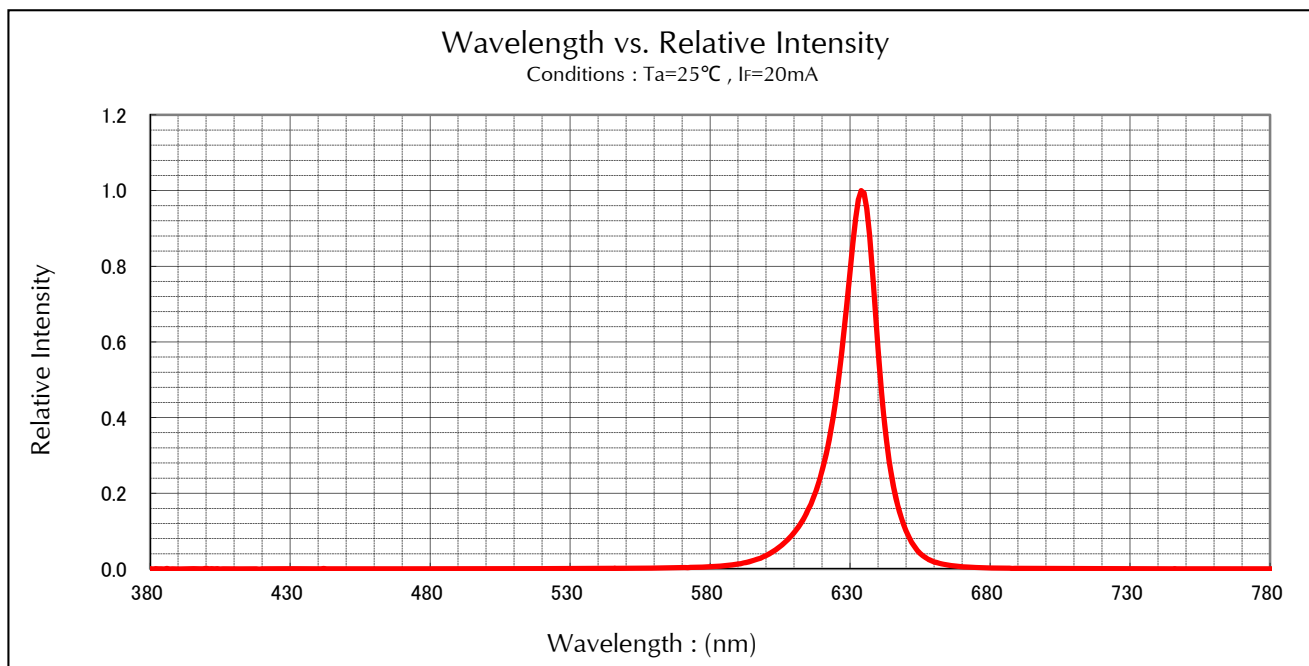
### 【Sorting Chart for Chromaticity Coordinates】

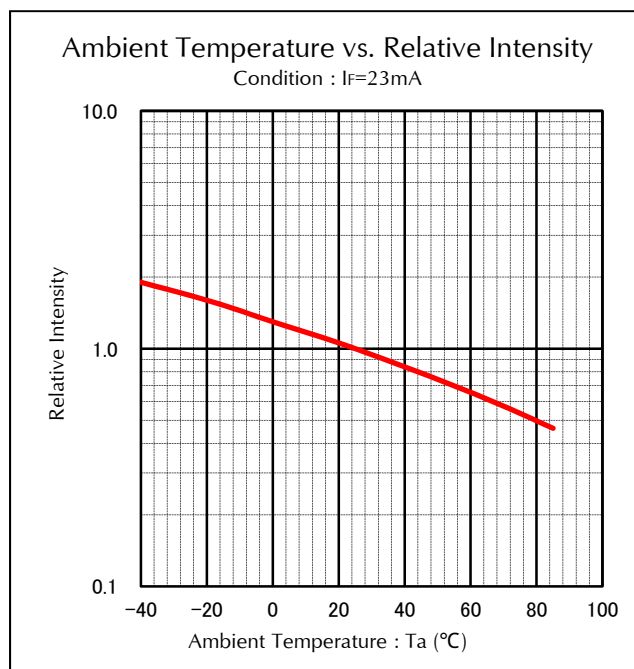
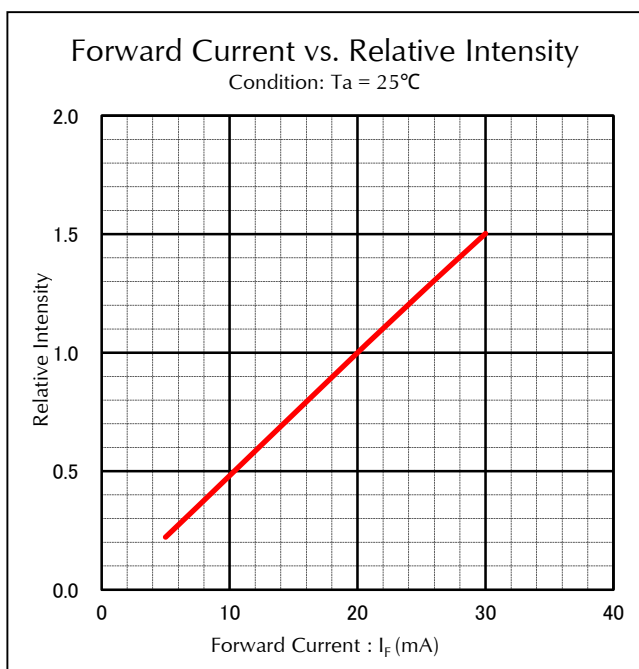
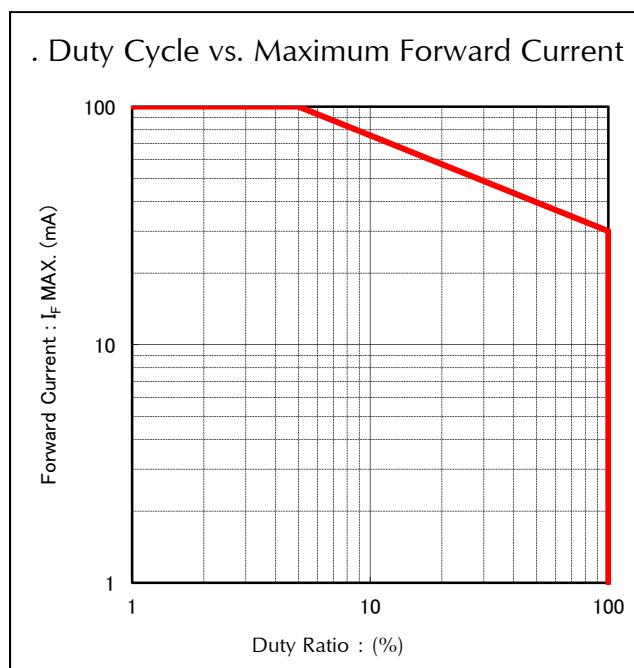
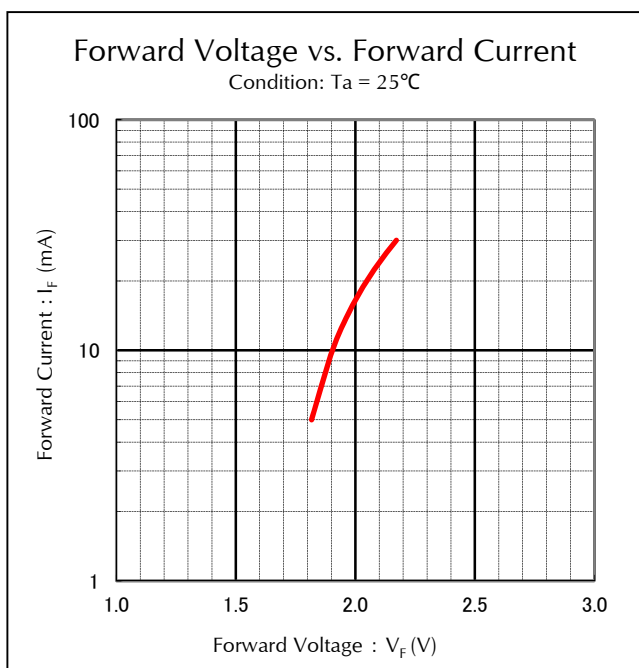
Chromaticity coordinates is sorted out into the following chat.

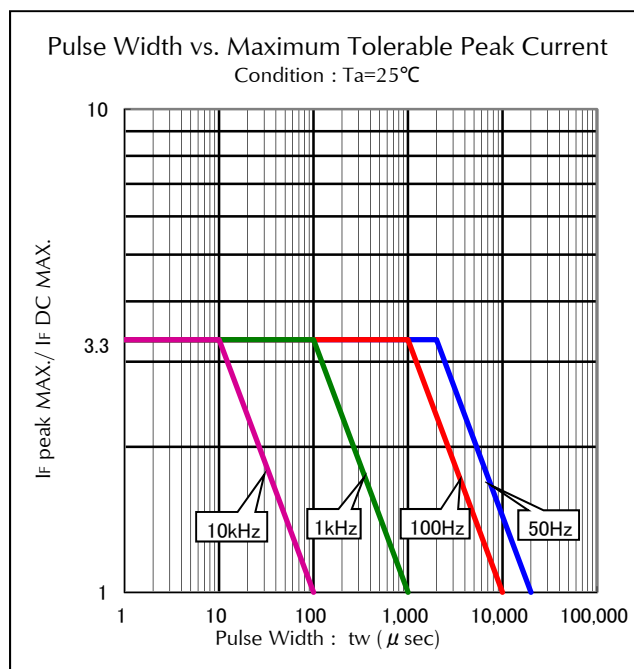
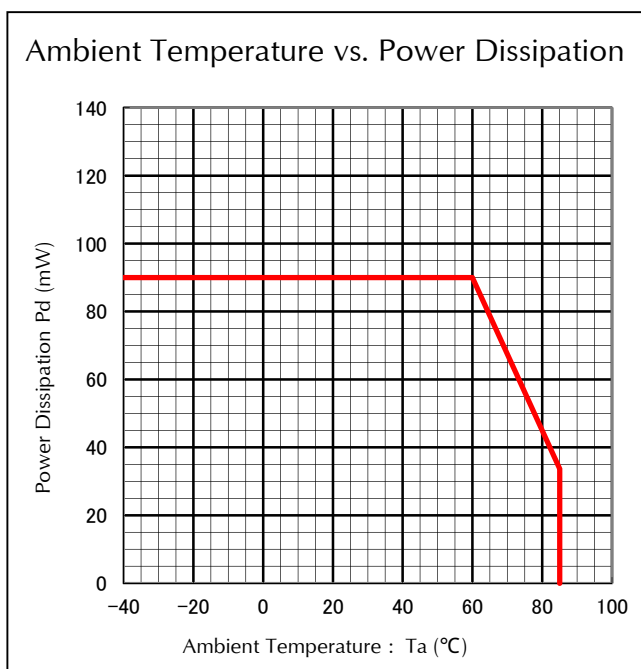
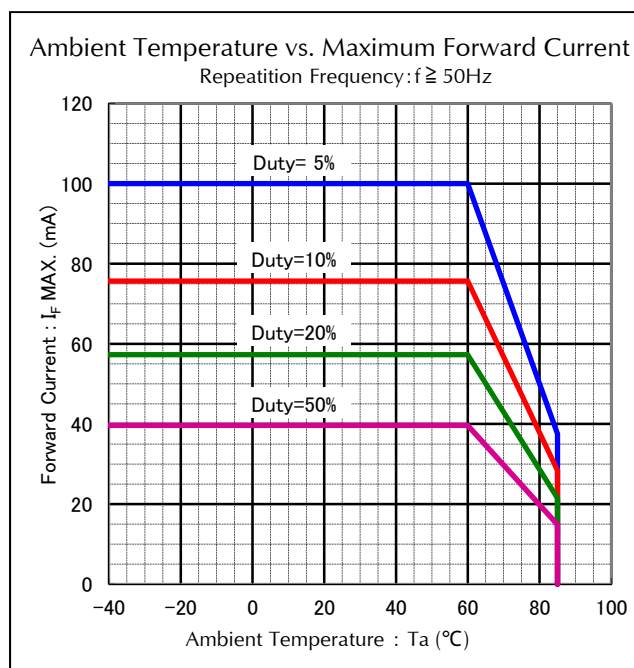
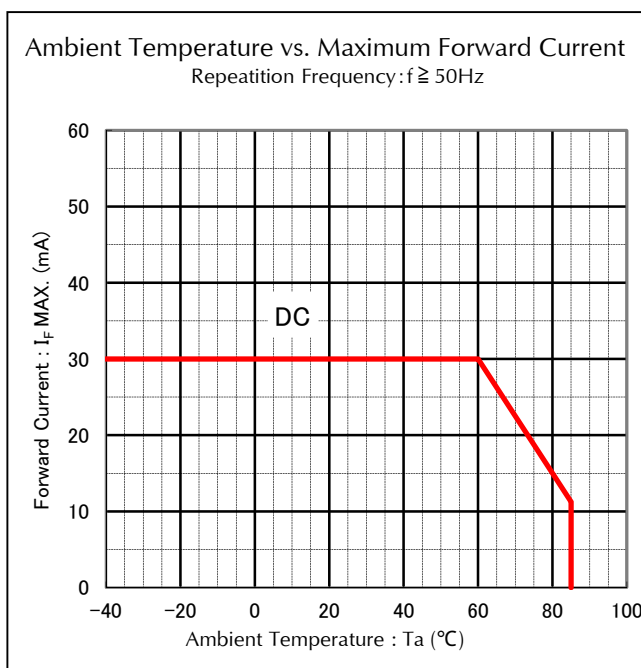


| RANK | Left Down |       | Left Up |       | Right Up |       | Right Down |       | CONDITONS               |
|------|-----------|-------|---------|-------|----------|-------|------------|-------|-------------------------|
|      | x         | y     | x       | y     | x        | y     | x          | y     |                         |
| A    | 0.240     | 0.330 | 0.240   | 0.380 | 0.290    | 0.390 | 0.290      | 0.340 | RED<br>( $I_F=23mA$ )   |
| B    | 0.290     | 0.340 | 0.290   | 0.390 | 0.340    | 0.410 | 0.340      | 0.360 |                         |
| C    | 0.340     | 0.360 | 0.340   | 0.410 | 0.390    | 0.420 | 0.390      | 0.370 |                         |
| D    | 0.240     | 0.280 | 0.240   | 0.330 | 0.290    | 0.340 | 0.290      | 0.290 | GREEN<br>( $I_F=23mA$ ) |
| E    | 0.290     | 0.290 | 0.290   | 0.340 | 0.340    | 0.360 | 0.340      | 0.310 |                         |
| F    | 0.340     | 0.310 | 0.340   | 0.360 | 0.390    | 0.370 | 0.390      | 0.320 |                         |
| G    | 0.240     | 0.230 | 0.240   | 0.280 | 0.290    | 0.290 | 0.290      | 0.240 | BLUE<br>( $I_F=14mA$ )  |
| H    | 0.290     | 0.240 | 0.290   | 0.290 | 0.340    | 0.310 | 0.340      | 0.260 |                         |
| J    | 0.340     | 0.260 | 0.340   | 0.310 | 0.390    | 0.320 | 0.390      | 0.270 |                         |

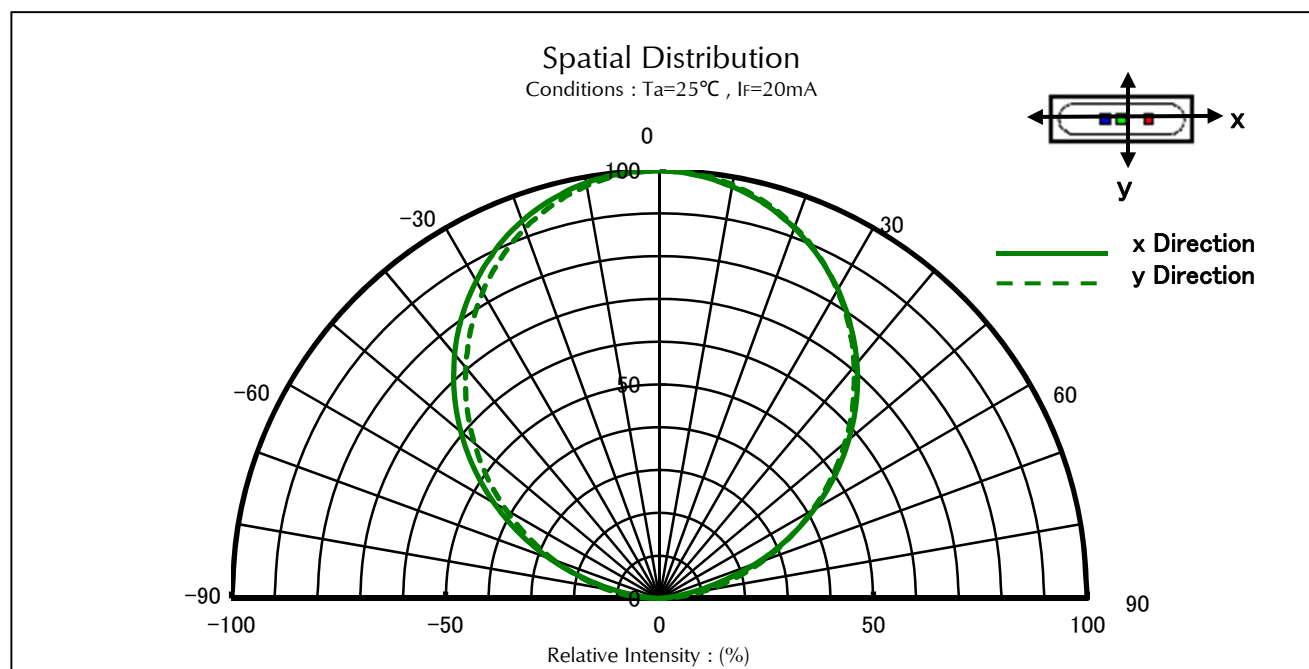
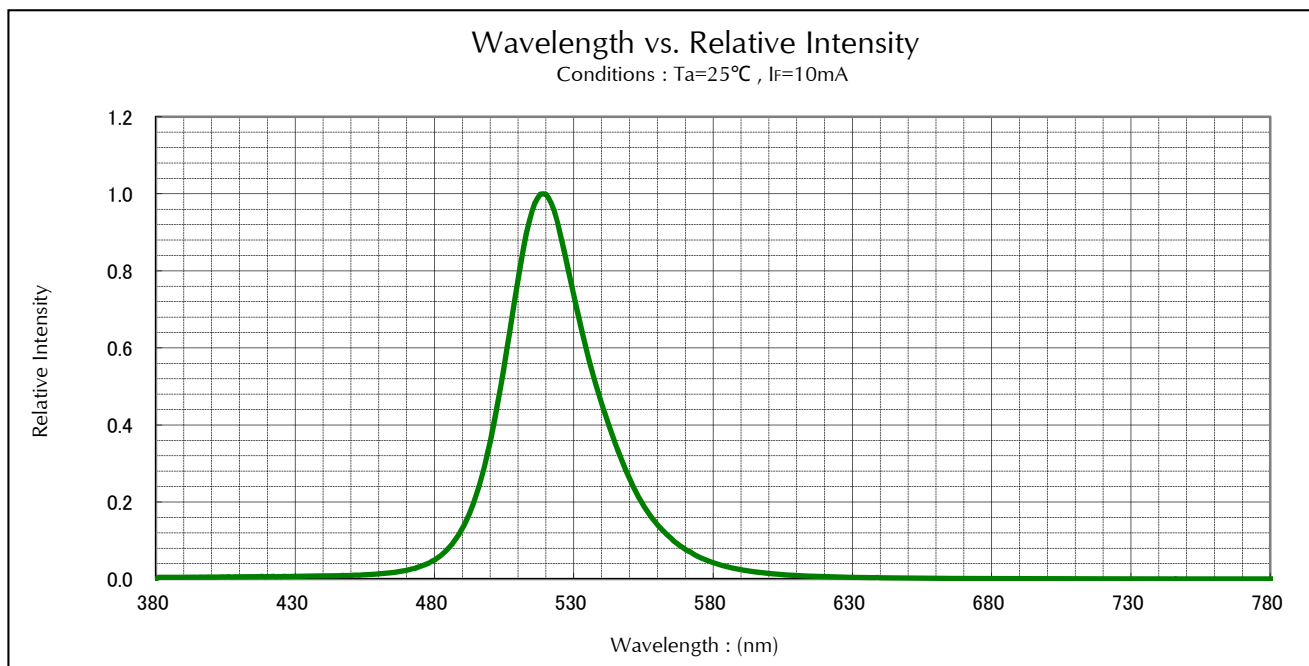
Notes Above chromaticity coordinates sorting values are values measured on Stanley's production line.  
(Tolerance :  $\pm 0.02$ )

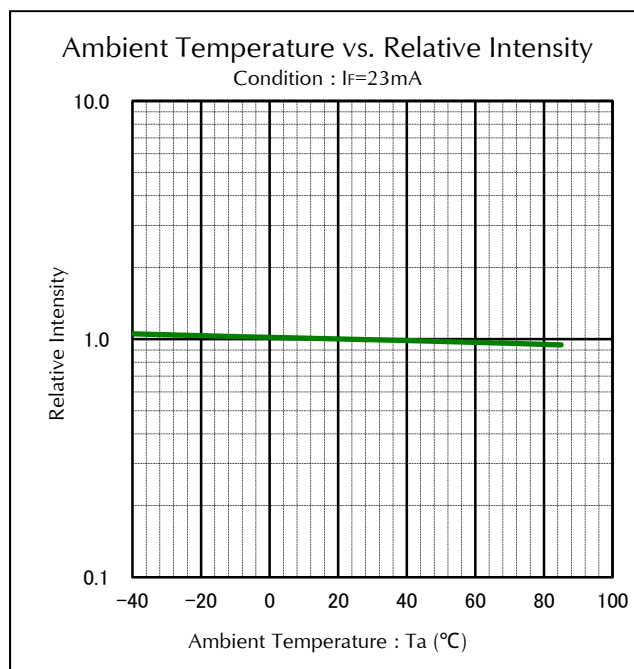
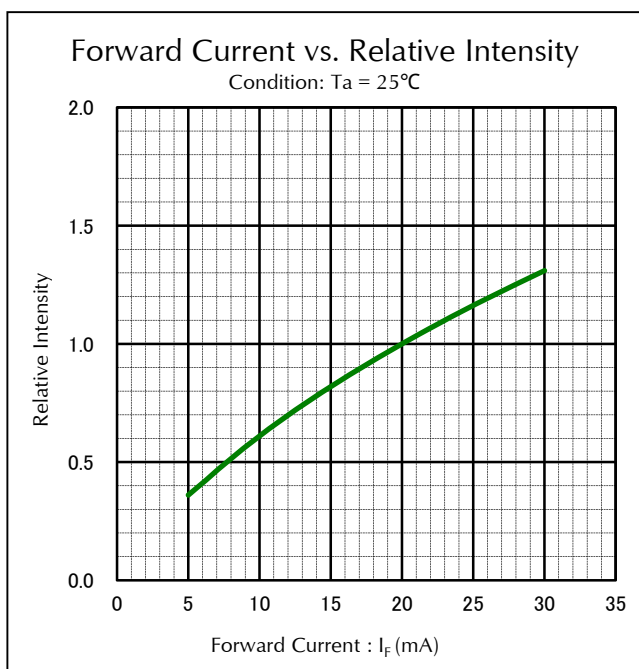
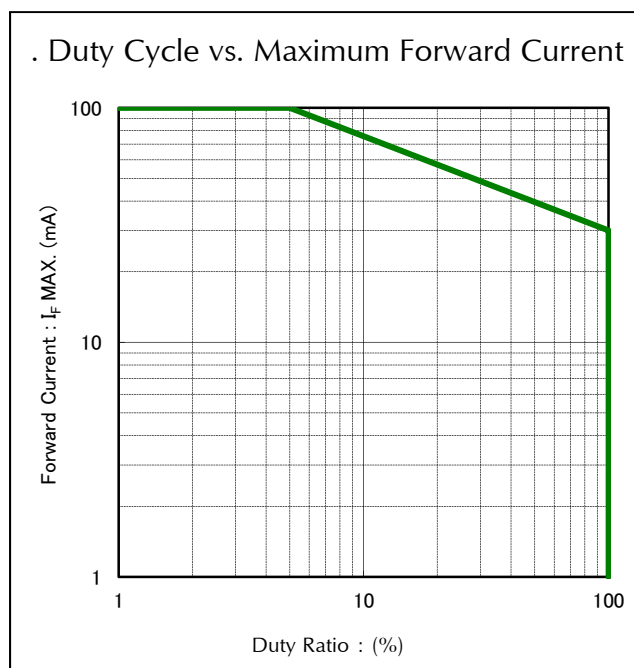
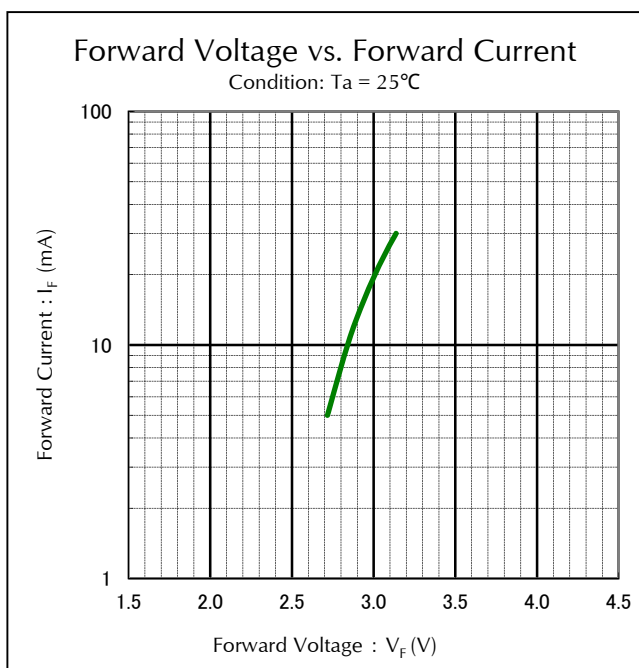


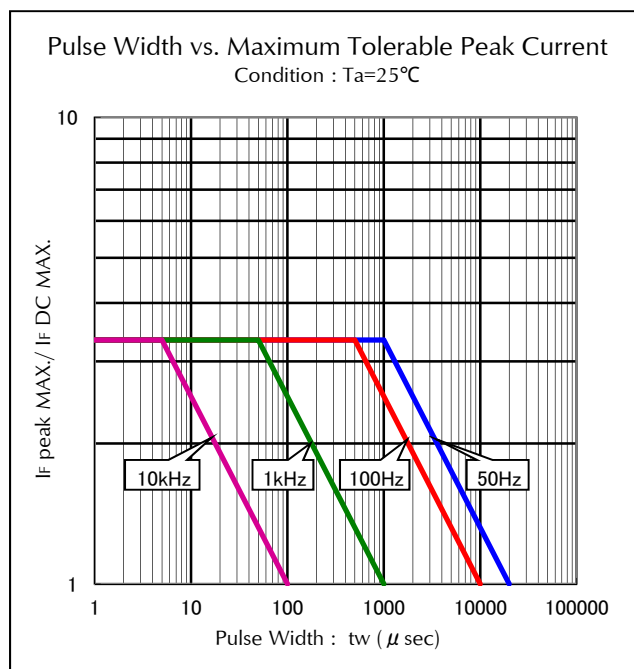
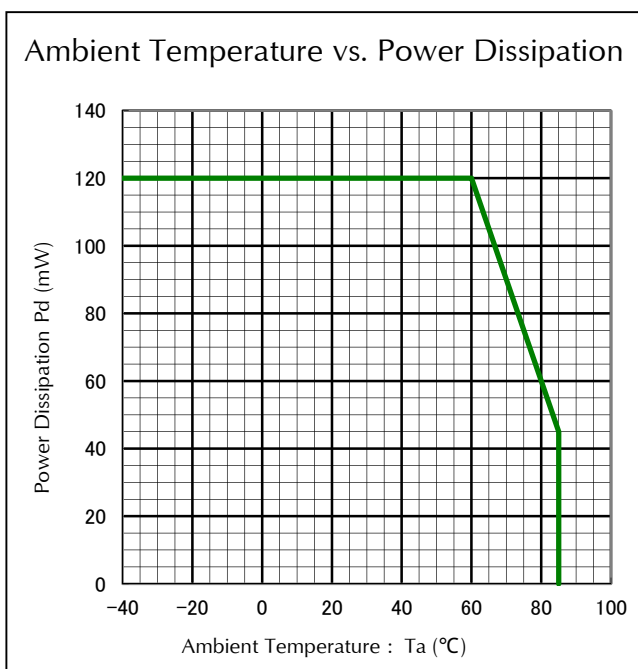
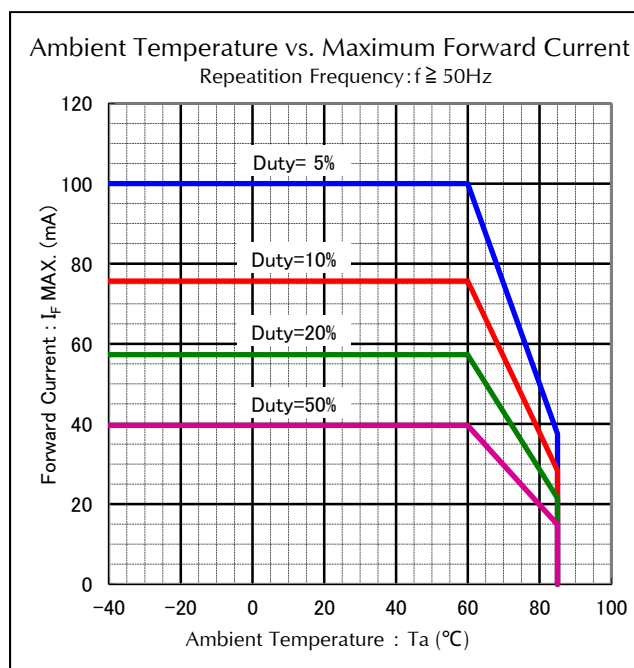
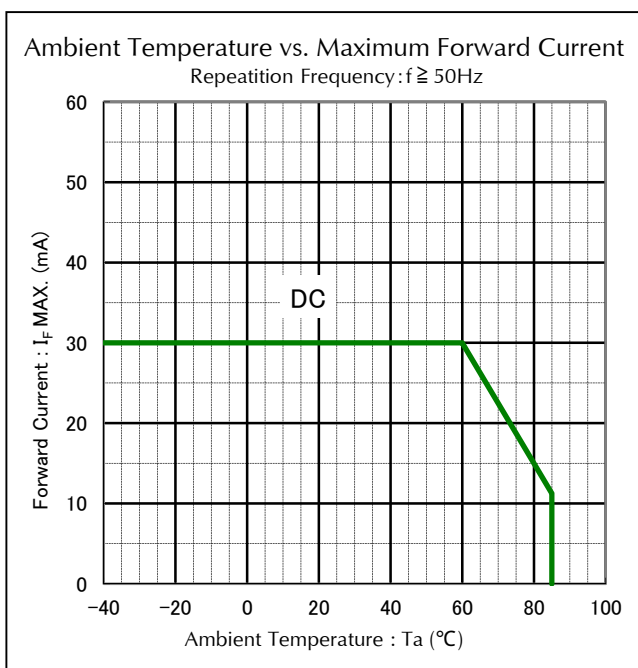


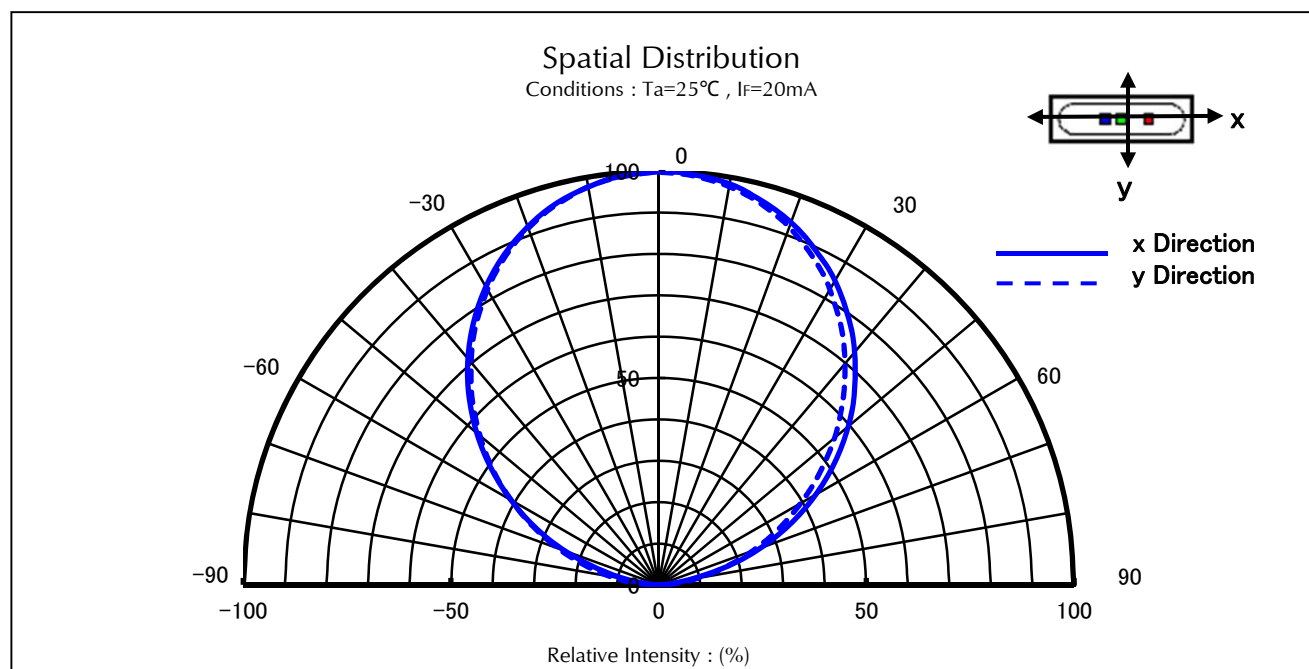
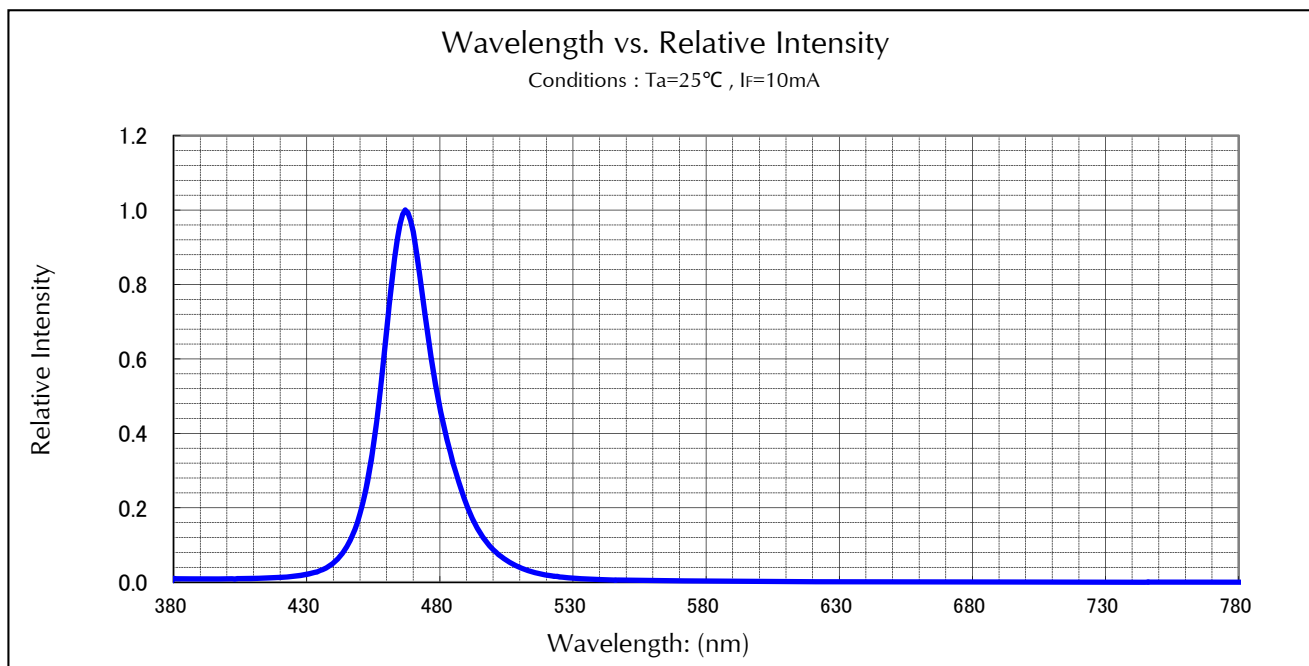


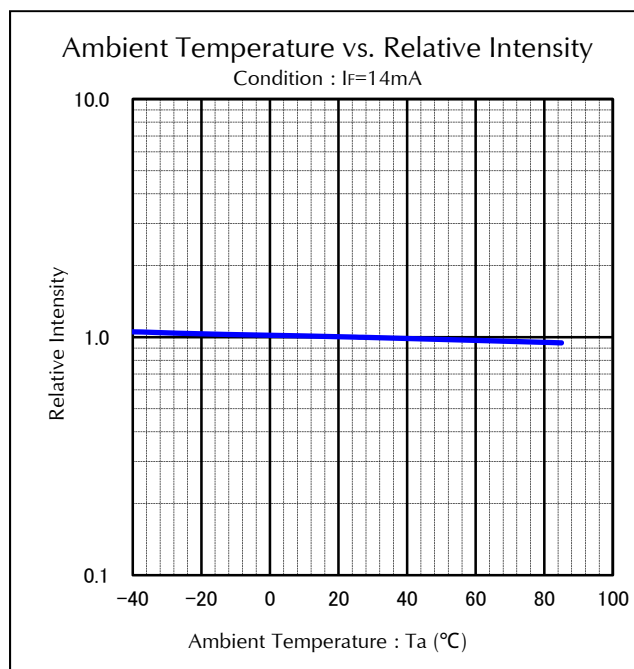
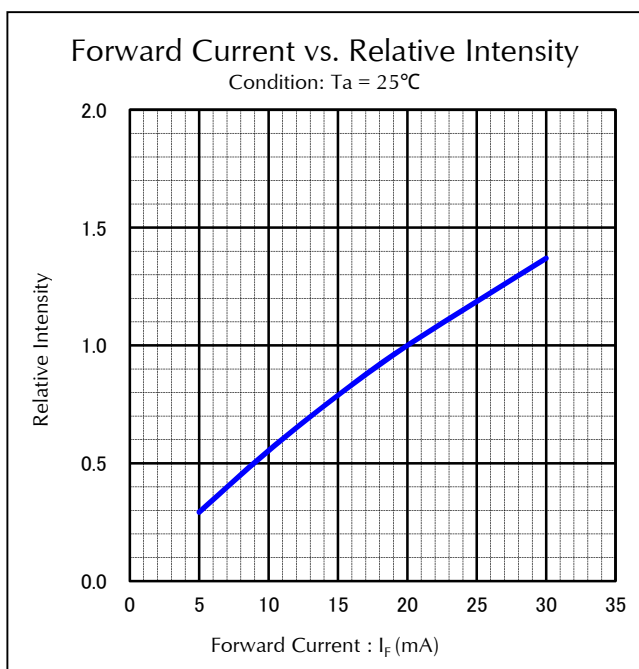
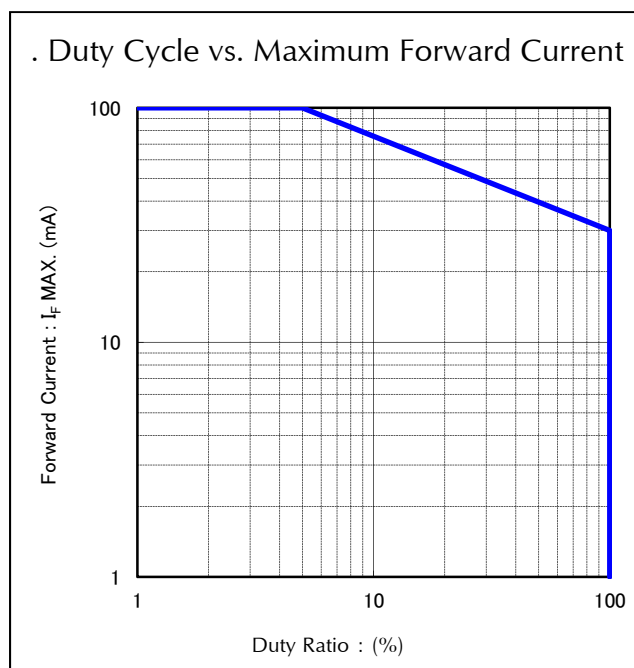
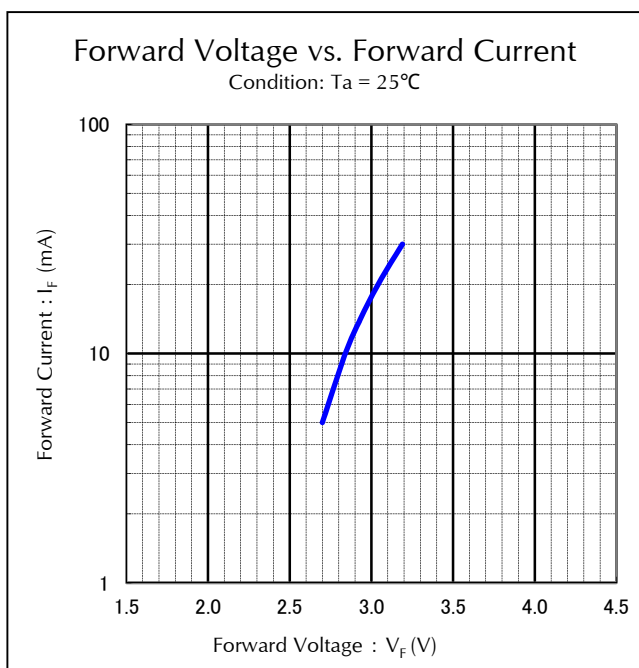


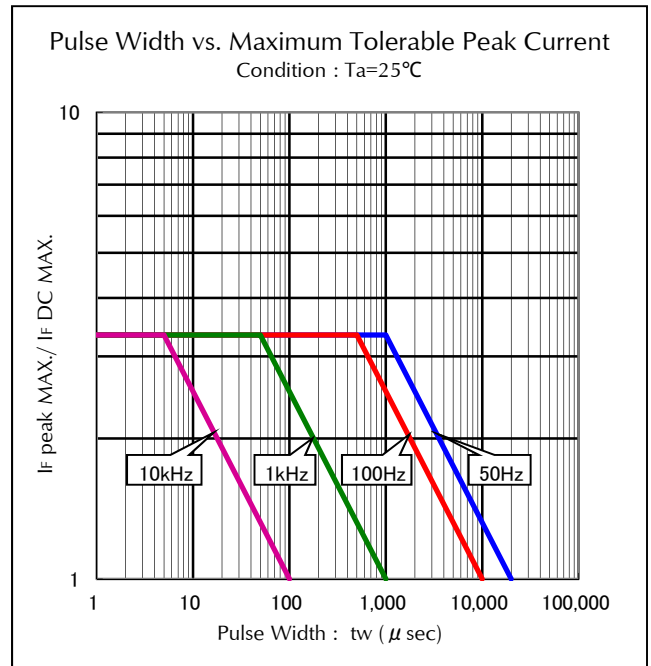
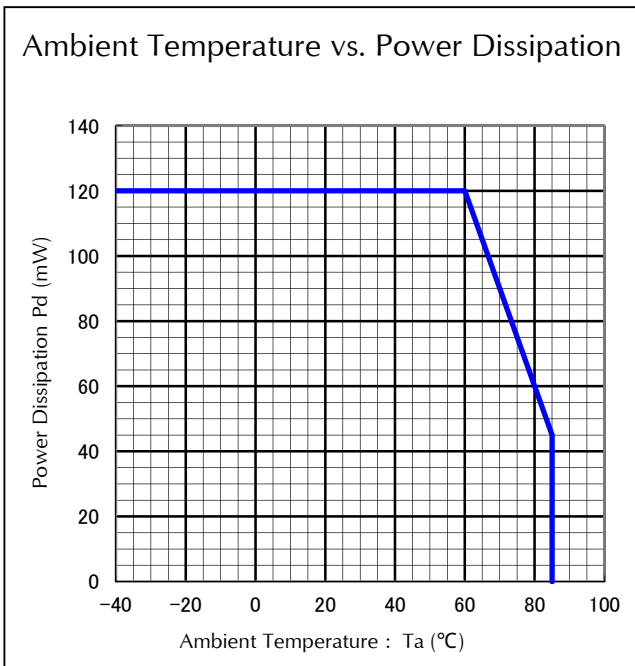
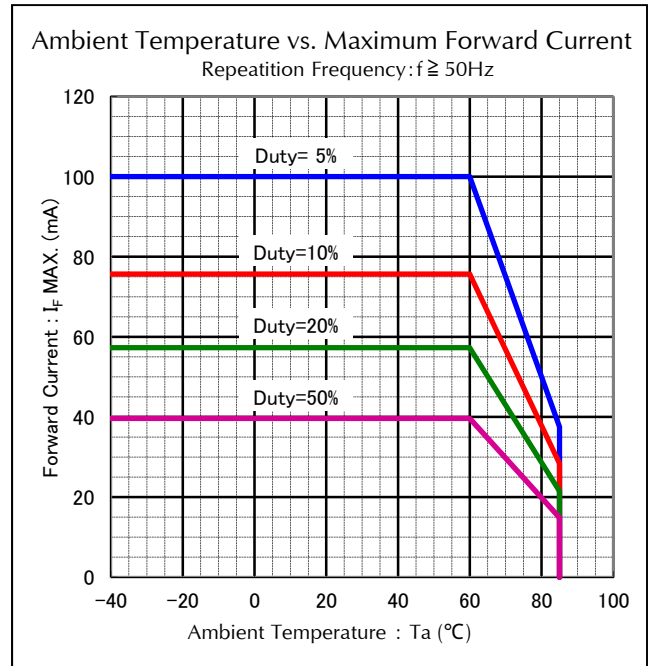
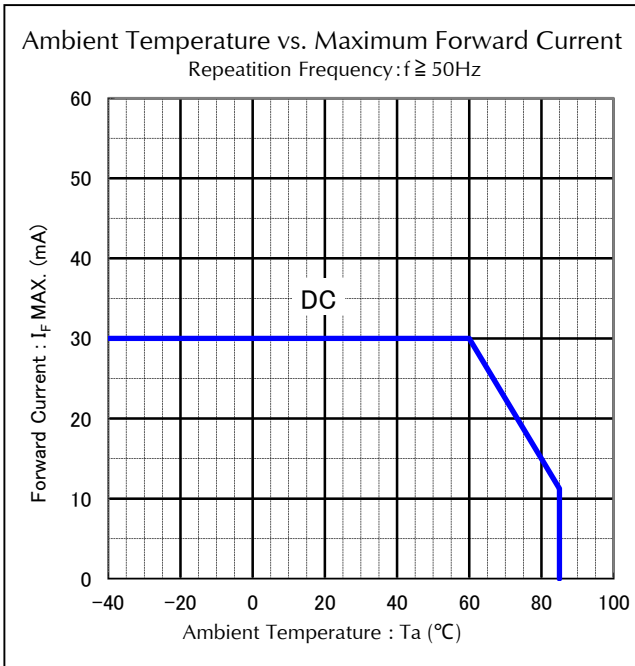


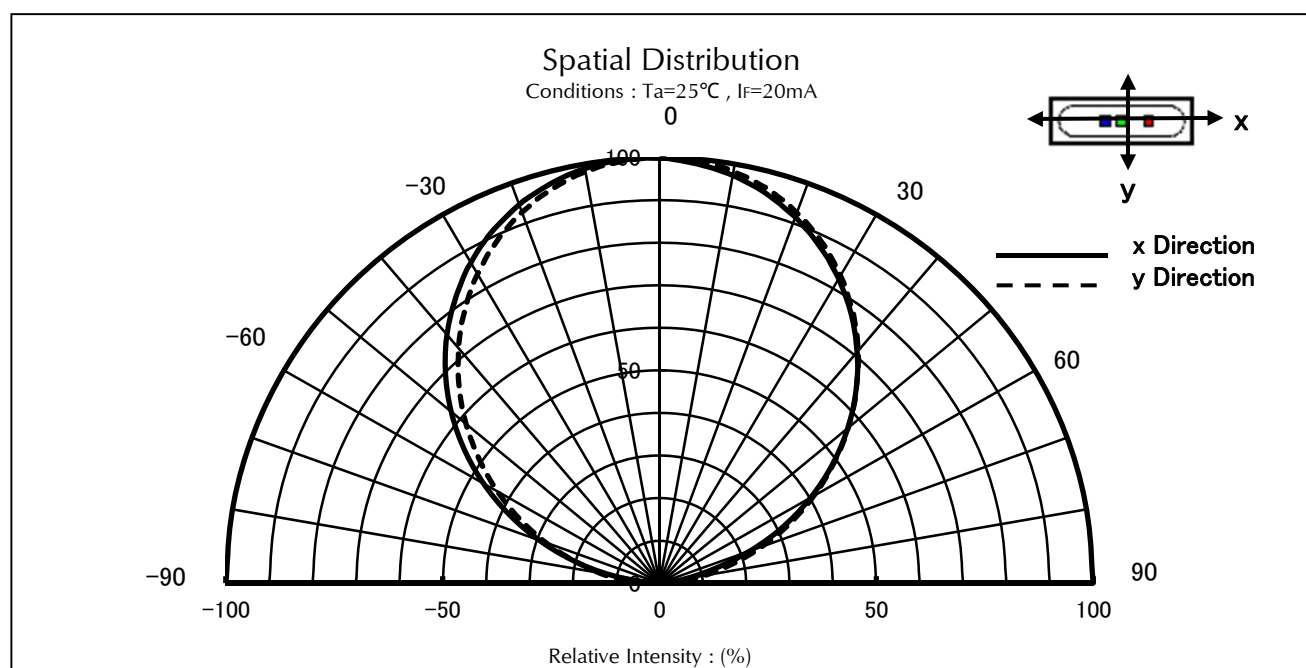
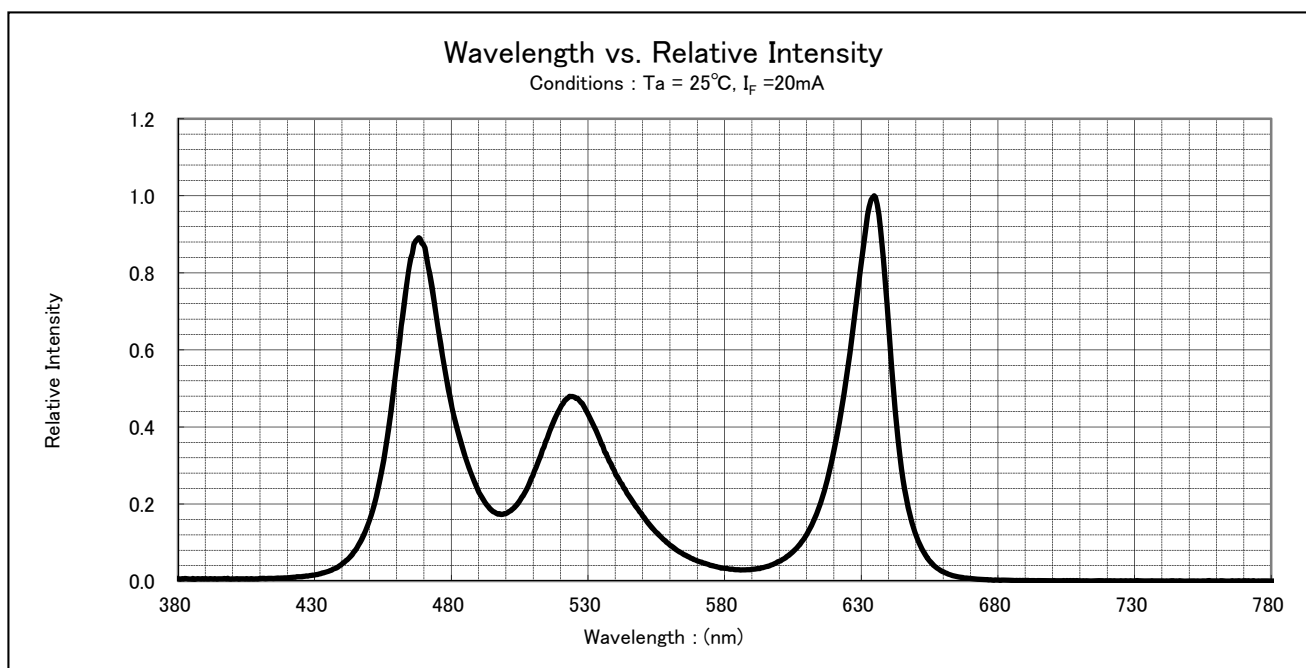










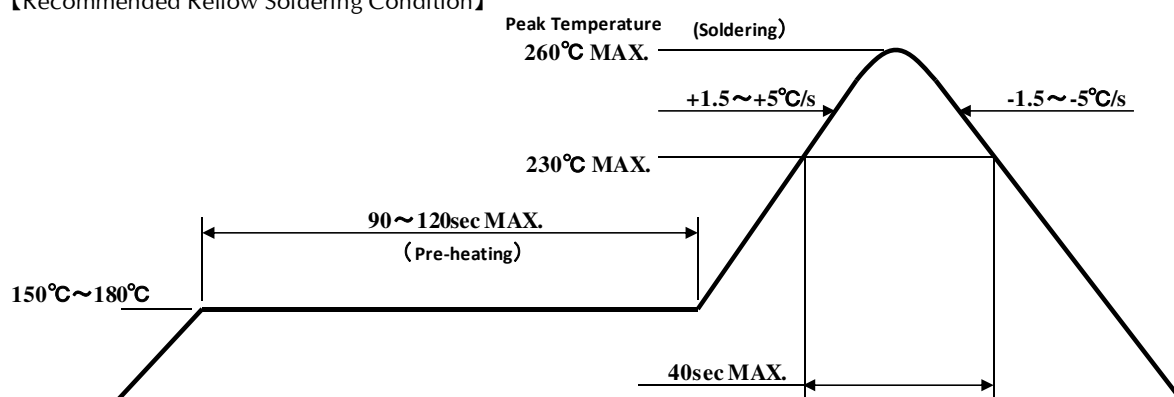


## 【Soldering Precaution】

(acc.to EIAJ-4701/300)

1. Heat stress during soldering will influence the reliability of LEDs, however that effect will vary with heating method. Also, if components with different shapes need to be mounted together, it is recommended to set the soldering pad temperature according to the component most vulnerable to heat stress (ex. SMT LED). (Recommended Condition: Soldering Pad temp. > Package temp.)
2. LED parts including the resin are not stable immediately after soldering ( when they are not at room temperature), any mechanical stress may cause damage to the product. Please avoid such stress after soldering, especially stacking of the boards which may cause the boards to warp and any other types of friction with hard materials.).
3. Recommended temperature profile for the Reflow soldering is listed as the temperature of the resin surface. Temperature distribution varies on heating method, PCB material, other components in the assembly, and mounting density .  
Please do not repeat the heating process in Reflow process more than twice.

## 【Recommended Reflow Soldering Condition】



Note 1 Recommended temperature profile for the reflow soldering is listed as the temperature of the resin surface. This should be the maximum temperature for soldering. Lowering the heating temperature and decreasing heating time is very effective in achieving higher reliability.

Note 2 The reflow soldering process should be done up to twice(2 times Max). When second process is performed, interval between first and second process should be as short as possible to prevent absorption of moisture to resin of LED. The second soldering process should not be done until LEDs have returned to room temperature (by nature-cooling) after first soldering process.



4. If soldering manually, Stanley recommends using a soldering iron equipped with temperature control. During the actual soldering process, make sure that the soldering iron never touches the LED itself, and avoid the LED's electrode heating temperature reaching above the heating temperature of the solder pad. All repairs must be performed only once in the same spot, and please avoid reusing components.
5. In soldering process, immediately after iron tip is cleaned, please make sure that the soldering iron reaches the appropriate temperature, before using. Also, please avoid applying any types of pressure to the soldered components before the solder has been cooled and hardened, as it may deteriorate solder performance and solder quality.

### 【Recommended Manual Soldering Condition.】

|                          |                    |
|--------------------------|--------------------|
| Temperature of Iron Tip  | 350°C MAX.         |
| Soldering Duration, Time | 3sec. Max., 1 time |

6. When using adhesive material for tentative fixatives, thermosetting resin or Ultraviolet radiation (UV) setting resin with heat shall be recommended. 《The curing condition, Temperature: 150°C Max./Time: 120sec. Max.》
7. Flow soldering (dip soldering) is not recommended for this product.
8. Isopropyl alcohol is recommended for cleaning. Some chemicals, including Freon substitute detergent could corrode the lens or the casing surface, which cause discoloration, cloud, crack and so on. Please review the reference chart below for cleaning. If water is used to clean (including the final cleaning process), please use pure water (not tap water), and completely dry the component before using.

| Chemical          | Adaptability |
|-------------------|--------------|
| Isopropyl Alcohol | ○            |
| Trichloroethylene | ×            |
| Chloroethene      | ×            |
| Acetone           | ×            |
| Thinner           | ×            |

## 【 For Electric Static Discharge ( ESD) 】

This kind of LED lamp is highly sensitive to surge voltage generated by the On/Off status change and discharges of static electricity through frictions with synthetic materials, which may cause severe damage to the die or undermine its reliability. Damaged products may experience conditions such as extremely high reverse voltage, or a decrease of forward rise voltage, deteriorating its optical characteristic.

Stanley products are designed to withstand up to 1,000V under the EIAJ ED-4701/300 Test #304 (HBM), and are packed with anti-static components. However, the following precautions and measures are vital in ensuring product quality during shipment.

EIAJ ED-4701/300(304/HBM) Electrification model: C=100pF, R2=1.5KΩ

### 1. Electrification/Static Electricity protection

Stanley recommends the following precautions in order to avoid product (die) damage from static electricity, when an operator and other materials electrified by friction coming in contact with the product.

- ① Do not place electrified non-conductive materials near the LED product.  
Avoid LED products from coming into contact with metallic materials.( Should the metallic material be electrified, the sudden surge voltage will most likely damage the product.)
- ② Avoid a working process which may cause the LED product to rub against other materials.
- ③ Install ground wires for any equipment, where they can be installed, with measures to avoid static electricity surges.
- ④ Prepare a ESD protective area by placing a Conductive Mattress (1MΩ MAX.) and Ionizer to remove any static electricity.
- ⑤ Operators should wear a protective wrist-strap.
- ⑥ Operators should wear conductive work-clothes and shoes.
- ⑦ To handle the products directly, Stanley recommends the use of ceramic, and not metallic, tweezers.

### 2. Working Environment

- ① A dry environment is more likely to cause static electricity. Although a dry environment is ideal for storage state of LED products, Stanley recommends an environment with approximately 50% humidity after the soldering process.
- ② Recommended static electricity level in the working environment is 150V, which is the same value as Integrated Circuits (which are sensitive to static electricity).

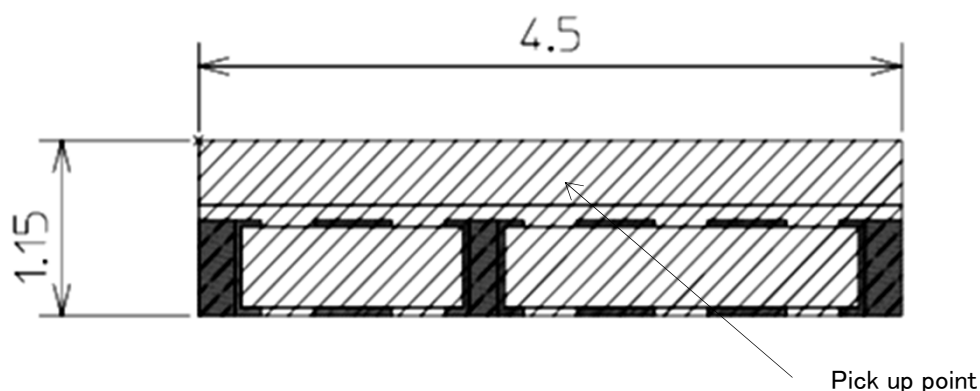
### 【 Other Precautions 】

1. Stanley LED Lamps have semiconductor characteristics and are designed to ensure high reliability. However, the performance may vary depending on usage conditions
2. Absolute Maximum Ratings are set to prevent LED lamps from failing due to excess stress( temperature, current, voltage, etc.). Usage conditions must not exceed the ratings for a moment, nor do reach one item of absolute maximum ratings simultaneously.
3. In order to ensure high reliability from LED Lamps, variable factors that arise in actual usage conditions should be taken into account for designing. ( Derating of TYP., MAX Forward Voltage, etc.)
4. Please insert Protective Resistors into the circuit in order to stabilize LED operation and to prevent the device from igniting due to excess current.
5. Please check the actual performance in the assembly because the Specification Sheets are described for LED device only.
6. Please refrain from looking directly at the light source of LED at high output, as it may harm your vision.
7. The products are designed to operate without failure in recommended usage conditions. However, please take the necessary precautions to prevent fire, injury, and other damages should any malfunction or failure arise.
8. The products are manufactured to be used for ordinary electronic equipment. Please contact our sales staff beforehand when exceptional quality and reliability are required, and the failure or malfunction of the products might directly jeopardize life or health ( such as for airplanes, aerospace, transport equipment, medical applications, nuclear reactor control systems and so on).
9. When there is a process of supersonic wave welding etc. after mounting the product, there is a possibility of affecting on the reliability of junction part in package (junction part of die bonding and wire bonding). Please make sure there is no problem before using.
10. The formal specification sheets shall be valid only by exchange of documents signed by both parties

【 Other Precautions for Product Mounting】

<Recommendation>

1. Product pick up point :  area of below figure



**Load : Less than 5N**  
(to avoid the product breaking)

2. Load : Less than 5N  
Please adjust the load, the pick up point, the nozzle diameter etc. before mounting, because lamp housing might get destroyed due to overload and improper shape of nozzle.  
Please set up vacuum breaker or air blower to make sure that product being putted down on soldering pad after it being picked up by nozzle.

This product is baked (moisture removal) before packaging, and is shipped in moisture-proof packaging (as shown below) to minimize moisture absorption during transportation and storage. However, with regard to storing the products, Stanley recommends the use of dry-box under the following conditions is recommended. Moisture-proof bag as the packaging is made of anti-static material but packaging box is not.

### 【Recommended Storage Condition / Products Warranty Period】

|             |           |
|-------------|-----------|
| Temperature | +5~30°C   |
| Humidity    | Under 70% |

In the case of the package unopened , 6 months under 【 Recommended Storage Condition 】, Please avoid rapid transition from low temp. condition to high temp. condition and storage in corroding and dusty environment.

### 【Time elapsed after Package Opening.】

The package should not be opened until immediately prior to its use, and please keep the time frame between package opening and soldering which is 【maximum 72h】. If the device needs to be soldered twice, both soldering operations must be completed within the 72h.

If any components should remain unused, please reseal the package and store them under the conditions described in the 【 Recommended Storage Condition 】, above.

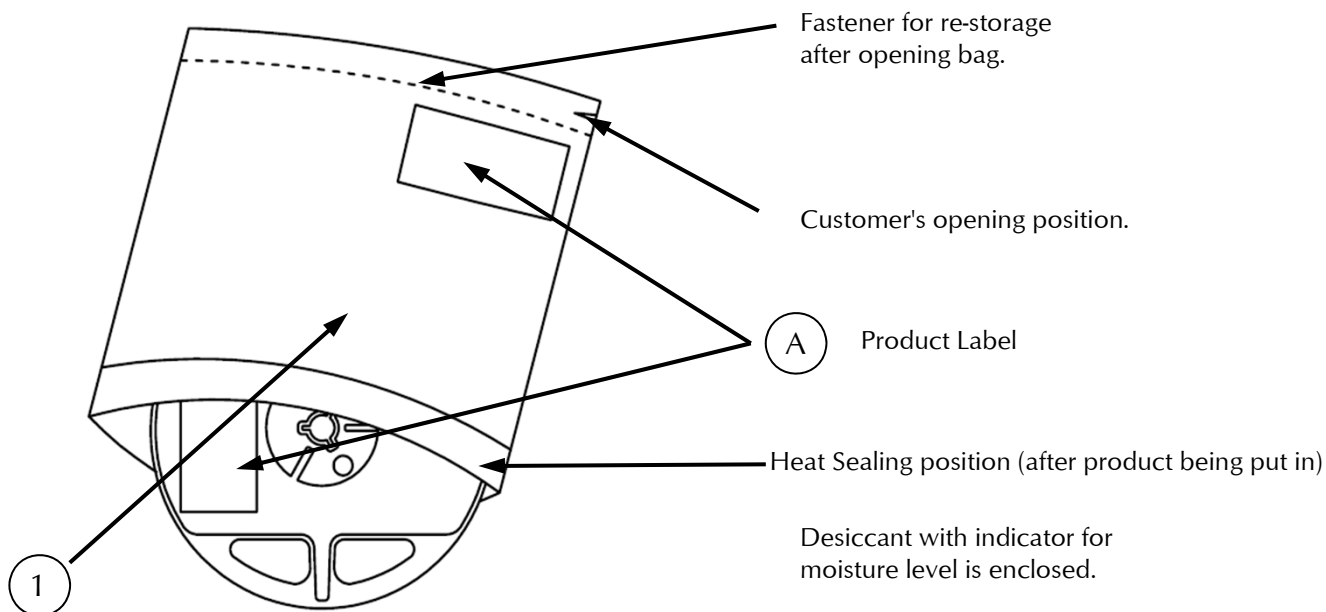
This product must be required to perform baking process (moisture removal) for at 48h( MIN.).~72h(MAX.) at 60±5 degrees Celsius if following conditions apply.

1. In the case of silica gel (blue) which indicates the moisture level within the package, changes or loses its blue color.
2. In the case of time passes for 72h after the package is opened once.

Baking process should be performed after LED having been taken out of the package.

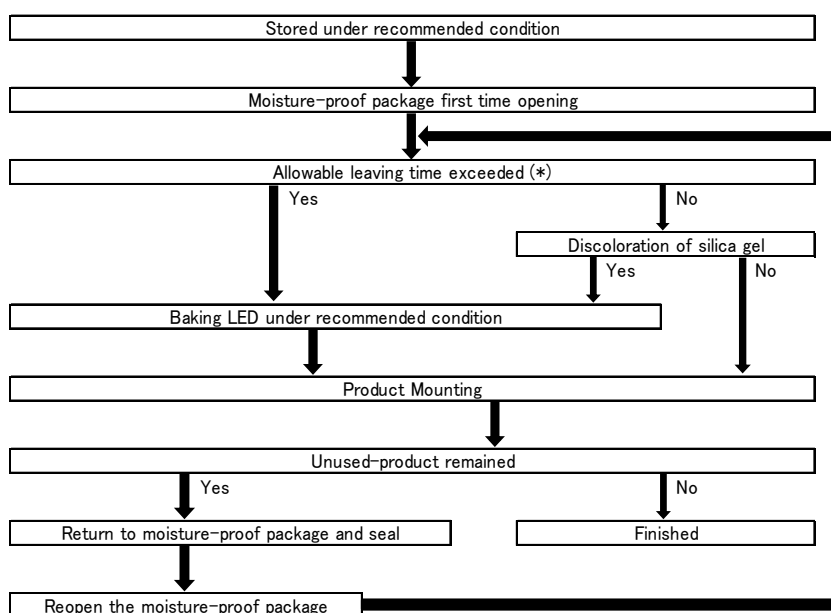
Baking may be performed in the tape-reel form , however if it is performed with the reel stacked over one another, it may cause deformation of the reels and taping materials and later obstruct mounting. Please handle only once it has returned to room temperature. Provided that, baking process shall be 2 times MAX.

1. Moisture-proof Bag



| SYMBOL | PART NAME                              | MATERIALS | REMARKS             |
|--------|--|-----------|---------------------|
| ①      | Moisture-proof bag with Aluminum layer | PET+Al+PE | with ESD protection |

【Flow Chart-package Opening to Mounting】



Allowable leaving time means the maximum allowable leaving time after opening package, which depends on each LED type. The allowable leaving time should be calculated from the first opening of package to the time when soldering process is finished. When judging if the allowable leaving time has exceeded or not, please subtract the soldering time. The allowable leaving time after reopening should be calculated from the first opening of package, or from the time when baking process is finished.

# Packaging Specifications

# ARGB1318FS-TM

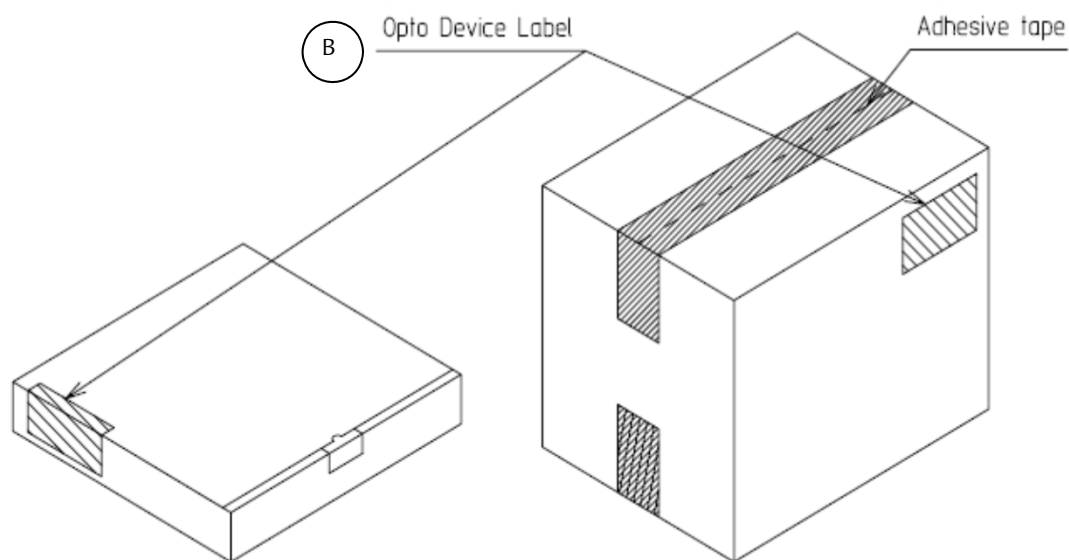
## 【 Packing box 】

(RoHS•ELV Compliant)

| Box TYPE | Outline dimension<br>L × W × H (mm) | Capacity of the box |
|----------|-------------------------------------|---------------------|
| Type A   | 280 × 265 × 45                      | 3 reels             |
| Type B   | 310 × 235 × 265                     | 15 reels            |
| Type C   | 440 × 310 × 265                     | 30 reels            |

The above measure is all the reference value.

The box is selected out of the above table, by shipping quantity.



Type A

Material / box : Cardboard C5BF

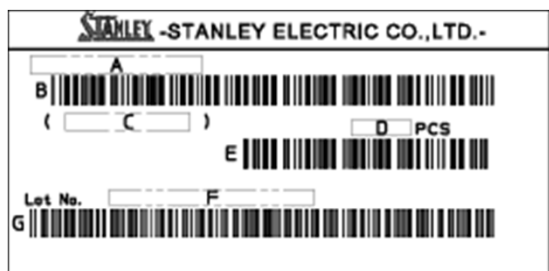
Type B,C

Material / box : Cardboard K5BF  
Partition : Cardboard K5BF

**【Label Specification】**

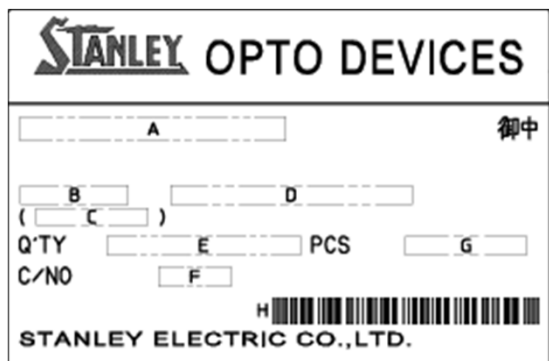
( acc.to JIS-X0503(Code-39))

**(A) Product Label**



- A. Parts number
- B. Bar-code for parts number
- C. Parts code (In-house identification code for each parts number)
- D. Packed parts quantity
- E. Bar-Code for packed parts quantity
- F. Lot number & Rank  
(refer to Lot Number Notational System for details)
- G. Bar-Code for Lot number & Rank

**(B) Opto Device Label**



- A. Customer Name
- B. Parts Type
- C. Parts Code
- D. Parts Number
- E. Packed Parts Quantity
- F. Carton Number
- G. Shipping Date
- H. Bar-Code for In-house identification Number

<Remarks> Bar-code font : acc.to Code-39(JIX0503)

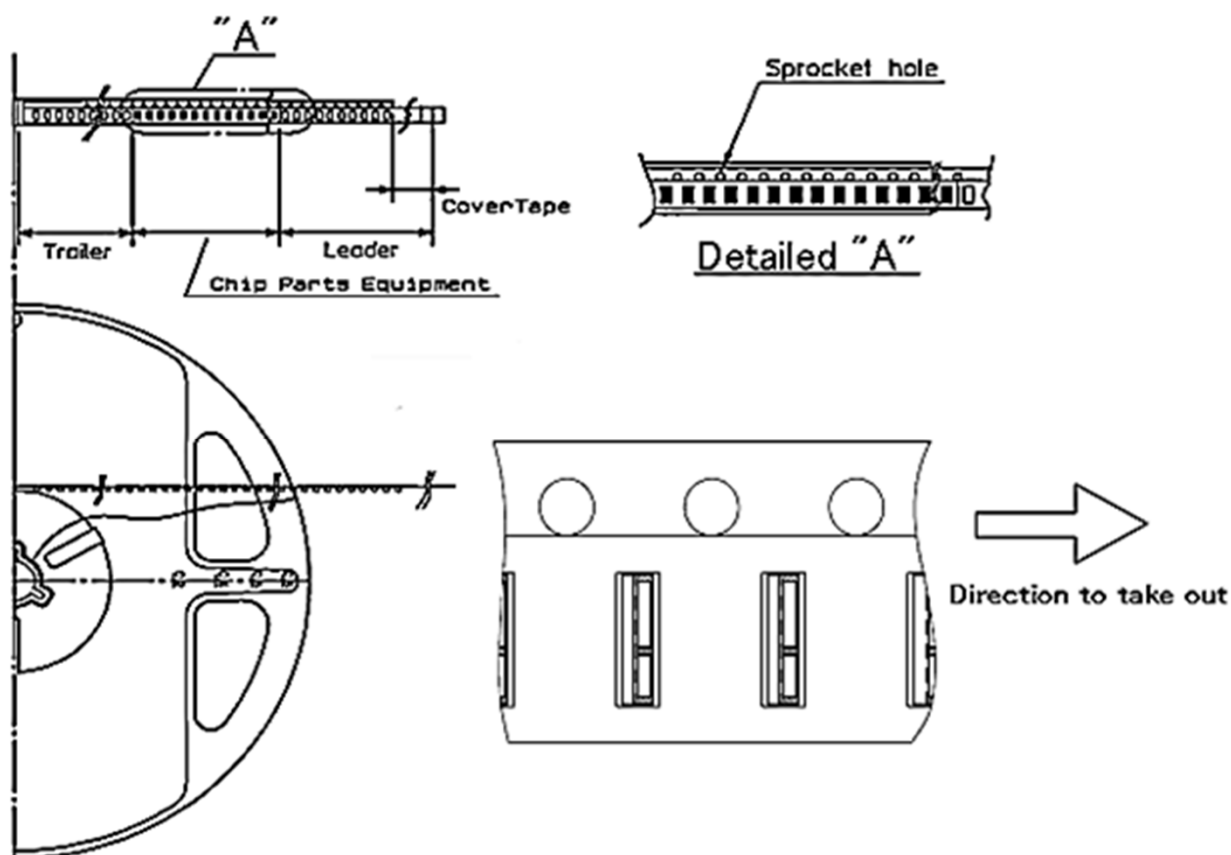


# Taping and Reel Specifications

ARGB1318FS-TM

(acc.to JIS-C0806)

## 【Appearance】



| Items        |              | Specifications   | Remarks   |
|--------------|--------------|--|---|
| Leader area  | Cover-tape   | Cover-tape shall be longer than 300mm without carrier-tape | The end of cover-tape shall be held with adhesive tape.         |
|              | Carrier-tape | Empty pocket shall be more than 25pieces.                  | Please refer to the above figure for Taping & reel orientation. |
| Trailer area |              | Empty pocket shall be more than 40pieces.                  | The end of taping shall be inserted into a slit of the hub.     |

### 【Qty. per Reel】

2,500 parts/reel (Note1)

Note1 Minimum Qty. per reel might be 500 parts when getting less than 2,500 parts. In such case, parts of 500-unit-qty. shall be packed in a reel and the qty. shall be identified on the label.

### 【 Mechanical strength】

Cover-tape adhesive strength shall be 0.1~1.0N

( An angle between carrier-tape and cover-tape shall be 170 deg. )

Both tapes shall be so sealed that the contained parts will not come out from the tape when it is bent at a radius of 15mm.

### 【Others】

Reversed-orientation, Up-side down placing, side placing and out of spec. parts mix shall not be held.

Max qty. of empty pocket per reel shall be defined as follows.

| QTY./reel | Max.QTY of empty pocket | Remarks        |
|-----------|-------------------------|----------------|
| 500       | 1                       | -              |
| 1,000     | 1                       | -              |
| 1,500     | 1                       | -              |
| 2,000     | 2                       | No continuance |
| 2,500     | 2                       | No continuance |

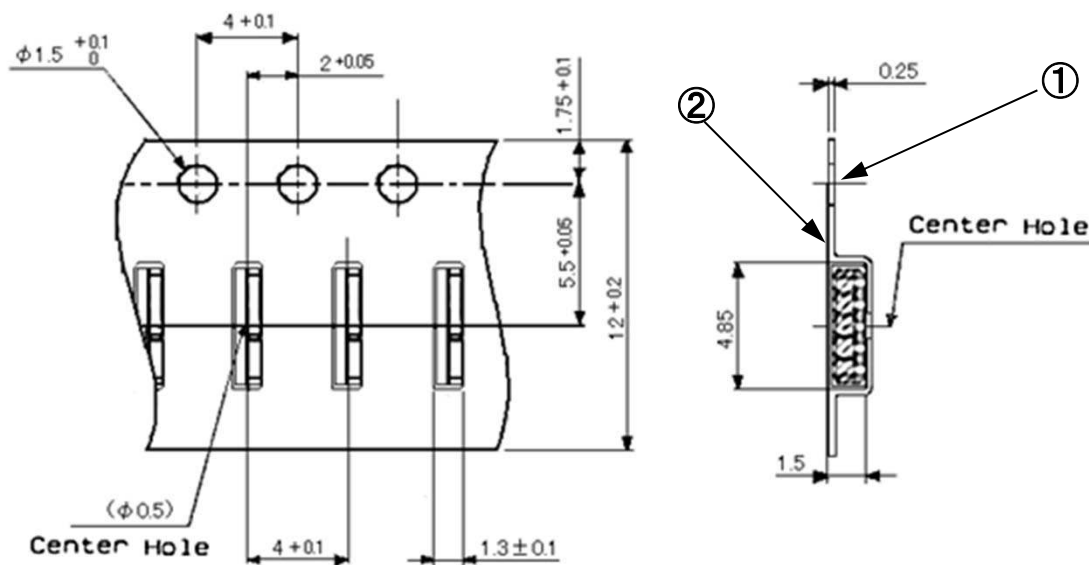
# Taping and Reel Specifications

ARGB1318FS-TM

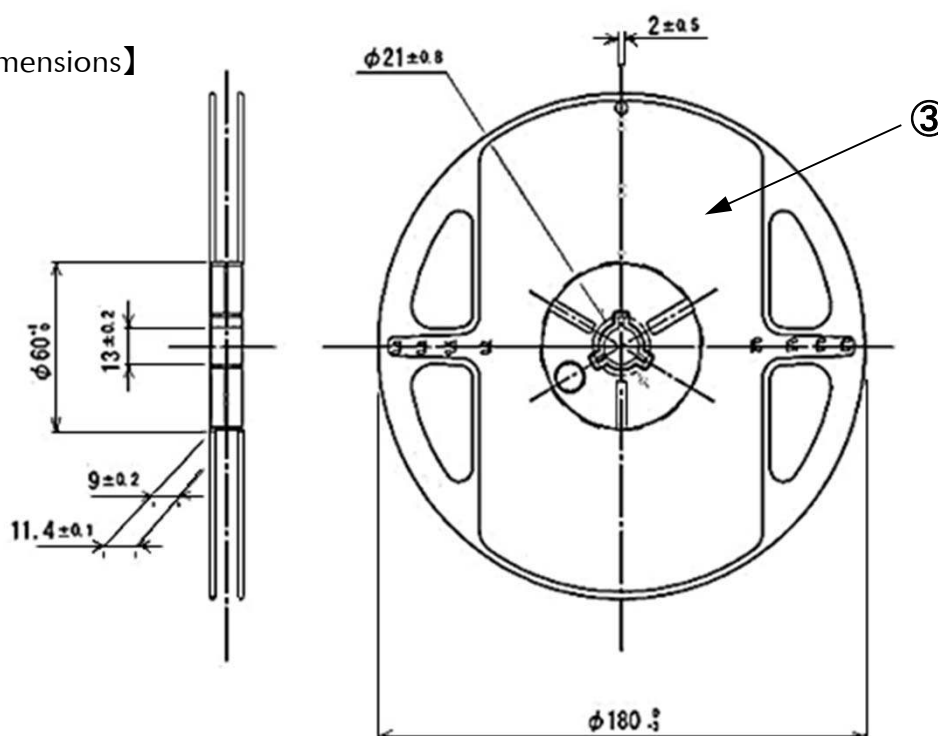
(acc.to JIS-C0806)

Unit :mm

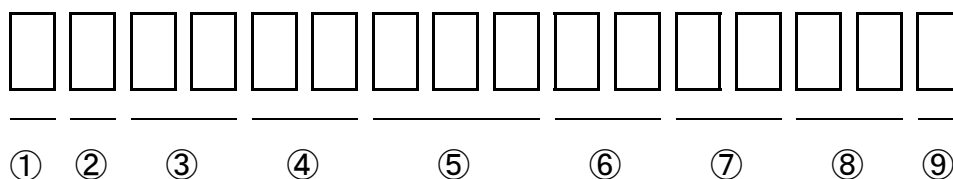
## 【Taping Dimensions】



## 【Reel Dimensions】



| SYMBOL | PART NAME    | REMARKS           |
|--------|--------------|-------------------|
| ①      | Carrier-tape | Conductive Grade  |
| ②      | Cover-tape   | Anti-Static Grade |
| ③      | Carrier-reel | Conductive Grade  |



① - 1digit : Production Location (Mark identify alphabet) : : : : :

② - 1digit : Production Year (Last digit of Production Year 2009→9,2010→0,2011→1,···)

③ - 2digits : Production Month (Jan. to Sep. , should be 01,02,03,·····)

④ - 2digits : Production Date

⑤ - 3digits : Serial Number

⑥ - 2digits : Tape and Reel following Number

⑦ - 2digits : Luminous Intensity Rank.  
 (If luminous intensity rank is 1 digit, "-" shall be dashed on the place for the second digit.  
 If there is no identified intensity rank, "- -" is used to indicate.)

⑧ - 2digits : Chromaticity Rank  
 (If chromaticity rank is 1 digit, "-" shall be dashed on the place for the second digit.  
 If there is no identified intensity rank, "- -" is used to indicate.)

⑨ - 1digit : Option Rank (Stanley normally print "-" to indicate)

This product is in compliance with RoHS▪ELV.

Prohibition substance and it's criteria value of RoHS▪ELV are as follows.

- ELV instruction ..... Refer to following (1)~(4).
- RoHS instruction ..... Refer to following (1)~(6).

|     | Substance Group Name      | Criteria Value |
|-----|---------------------------|----------------|
| (1) | Lead and its compounds    | 1,000ppm Max   |
| (2) | Cadmium and its compounds | 100ppm Max     |
| (3) | Mercury and its compounds | 1,000ppm Max   |
| (4) | Hexavalent chromium       | 1,000ppm Max   |
| (5) | PBB                       | 1,000ppm Max   |
| (6) | PBDE                      | 1,000ppm Max   |

## Reliability Testing Result

| Test Item                           | Applicable Standard    | Test Condition   | Duration              | Failure    |
|-------------------------------------|------------------------|--|-----------------------|------------|
| Operating Life                      | EIAJ ED-4701 /100(101) | Ta=25°C I <sub>F</sub> =Maximum Rated Current  | 1,000h                | 0 / 20     |
| High Temperature Operating Life     | EIAJ ED-4701 /100(101) | Ta=85°C I <sub>F</sub> =Maximum Rated Current ※ 1  | 1,000h                | 0 / 20     |
| Low Temperature Operating Life      | EIAJ ED-4701/100(101)  | Ta=-40°C I <sub>F</sub> =Maximum Rated Current   | 1,000h                | 0 / 20     |
| Wet High Temperature Operating Life | EIAJ ED-4701/100(102)  | Ta=60°C Rh=90% I <sub>F</sub> =Maximum Rated Current   | 1,000h                | 0 / 20     |
| Thermal Shock                       | EIAJ ED-4701/100(105)  | Ta= Tstg max. ~ Tstg min.<br>(each 15min)  | 200cycles             | 0 / 20     |
| Resistance to Reflow Soldering      | EIAJ ED-4701/300(301)  | Moisture Soak : 30°C 70% 72h<br>Preheating : 150~180°C 90~ 120sec MAX.<br>Soldering : 260°C MAX. | twice                 | 0 / 20     |
| Electrostatic Discharge (ESD)       | EIAJ ED-4701/300(304)  | C=100pF R2=1.5kΩ ±1,000V   | once of each polarity | 0 / 10 ※ 2 |

※ 1 Maximum Rated Current at Maximum Rated Operating Temperature

※ 2 Reference Test

## Failure Criteria

| Item                | Symbol         | Conditions  | Failure Criteria                                |
|---------------------|----------------|---|---|
| Luminous Intensity  | I <sub>V</sub> | I <sub>F</sub> value of each product's luminous intensity | Testing Min. Value < Spec. Min. Value × 0.5     |
| Forward Voltage     | V <sub>F</sub> | I <sub>F</sub> value of each product's forward voltage    | Testing Max. Value ≥ Spec. Max. Value × 1.2     |
| Cosmetic appearance | -              | -   | Notable Discoloration, Deformation and Cracking |

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